Complementary Bias Resistor Transistors R1 = 4.7 k\Omega, R2 = 47 k Ω

NPN and PNP Transistors with Monolithic Bias Resistor Network

ON

ON Semiconductor®

www.onsemi.com

PIN CONNECTIONS

(2)

q

(1)

(3)

(4)

MUN5333DW1, NSBC143ZPDXV6, NSBC143ZPDP6

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C both polarities Q₁ (PNP) & Q₂ (NPN), unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Base Voltage	V _{CBO}	50	Vdc
Collector-Emitter Voltage	V _{CEO}	50	Vdc
Collector Current – Continuous	Ι _C	100	mAdc
Input Forward Voltage	V _{IN(fwd)}	30	Vdc
Input Reverse Voltage	V _{IN(rev)}	5	Vdc

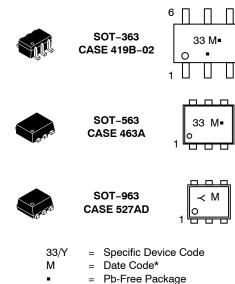
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

Device	Package	Shipping [†]
MUN5333DW1T1G, NSVMUN5333DW1T1G*	SOT-363	3,000/Tape & Reel
NSVMUN5333DW1T3G*	SOT-363	10,000/Tape & Reel
NSBC143ZPDXV6T1G NSVBC143ZPDXV6T1G*	SOT-563	4,000/Tape & Reel
NSVBC143ZPDXV6T5G*	SOT-563	8,000/Tape & Reel
NSBC143ZPDP6T5G	SOT-963	8,000/Tape & Reel

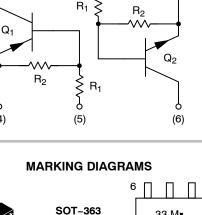
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Downloaded from Arrow.com.



(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.



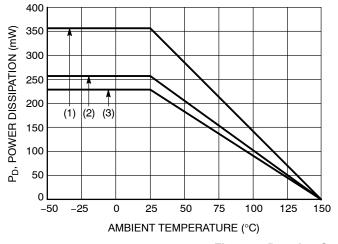
THERMAL CHARACTERISTICS

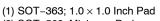
	Characteristic	Symbol	Max	Unit
MUN5333DW1 (SOT-363) ON	E JUNCTION HEATED			
$\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 1) \\ (Note 2) \\ \mbox{Derate above } 25^\circ C \\ (Note 2) \end{array}$	(Note 1)	PD	187 256 1.5 2.0	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	R _{θJA}	670 490	°C/W
MUN5333DW1 (SOT-363) BO	TH JUNCTION HEATED (Note 3)			
$\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 1) \\ (Note 2) \\ \mbox{Derate above } 25^\circ C \\ (Note 2) \end{array}$	(Note 1)	PD	250 385 2.0 3.0	mW mW/°C
Thermal Resistance, Junction to Ambient (Note 2)	(Note 1)	R _{θJA}	493 325	°C/W
Thermal Resistance, Junction to Lead (Note 1) (Note 2)		R _{θJL}	188 208	°C/W
Junction and Storage Temperation	ature Range	T _J , T _{stg}	-55 to +150	°C
NSBC143ZPDXV6 (SOT-563)	ONE JUNCTION HEATED		· · ·	
$\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 1) \\ \mbox{Derate above } 25^\circ C \end{array}$	(Note 1)	P _D	357 2.9	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 1)	R _{0JA}	350	°C/W
NSBC143ZPDXV6 (SOT-563)	BOTH JUNCTION HEATED (Note 3)			
$\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C & (Note 1) \\ \mbox{Derate above } 25^\circ C \end{array}$	(Note 1)	PD	500 4.0	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 1)	R _{θJA}	250	°C/W
Junction and Storage Temperation	ature Range	T _J , T _{stg}	-55 to +150	°C
NSBC143ZPDP6 (SOT-963)	ONE JUNCTION HEATED			
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 4) (Note 5) Derate above 25^{C} (Note 5)	(Note 4)	PD	231 269 1.9 2.2	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 5)	(Note 4)	R _{θJA}	540 464	°C/W
NSBC143ZPDP6 (SOT-963) E	BOTH JUNCTION HEATED (Note 3)		1 1	
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 4) (Note 5) Derate above 25^{C} (Note 5)	(Note 4)	PD	339 408 2.7 3.3	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 5)	(Note 4)	R _{θJA}	369 306	°C/W
Junction and Storage Temperation	ativa Danaa	T _J , T _{stg}	-55 to +150	°C

FR-4 @ 1.0 × 1.0 Inch Pad.
 FR-4 @ 1.0 × 1.0 Inch Pad.
 Both junction heated values assume total power is sum of two equally powered channels.
 FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector-Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	-	_	100	nAdc
Collector-Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I _{CEO}	-	-	500	nAdc
Emitter-Base Cutoff Current $(V_{EB} = 6.0 \text{ V}, I_C = 0)$	I _{EBO}	-	-	0.18	mAdc
Collector-Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V _{(BR)CBO}	50	-	-	Vdc
Collector-Emitter Breakdown Voltage (Note 6) $(I_C = 2.0 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	50	-	_	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 6) $(I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V})$	h _{FE}	80	200	-	
Collector-Emitter Saturation Voltage (Note 6) ($I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$)	V _{CE(sat)}	-	-	0.25	V
Collector-Emitter Saturation Voltage (MUN5333DW1) (Note 6) $(I_{\rm C} = 5 \text{ mA}, I_{\rm B} = 0.25 \text{ mA})$	V _{CE(sat)}	-	-	0.1	V
Input Voltage (Off) $(V_{CE} = 5.0 \text{ V}, I_{C} = 100 \mu\text{A}) \text{ (NPN)}$ $(V_{CE} = 5.0 \text{ V}, I_{C} = 100 \mu\text{A}) \text{ (PNP)}$	V _{i(off)}	- -	0.6 0.67		Vdc
Input Voltage (On) ($V_{CE} = 0.2 \text{ V}, I_C = 5.0 \text{ mA}$) (NPN) ($V_{CE} = 0.2 \text{ V}, I_C = 5.0 \text{ mA}$) (PNP)	V _{i(on)}	-	0.9 0.91		Vdc
Output Voltage (On) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 k Ω)	V _{OL}	-	-	0.2	Vdc
Output Voltage (Off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V _{OH}	4.9	-	_	Vdc
Input Resistor	R1	3.3	4.7	6.1	kΩ
Resistor Ratio	R ₁ /R ₂	0.08	0.1	0.14	

6. Pulsed Condition: Pulse Width = 300 ms, Duty Cycle \leq 2%.

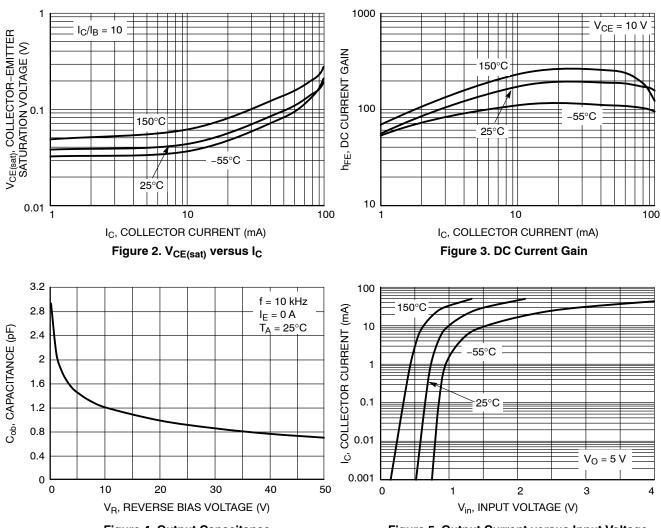




(2) SOT-563; Minimum Pad

(3) SOT-963; 100 mm², 1 oz. Copper Trace

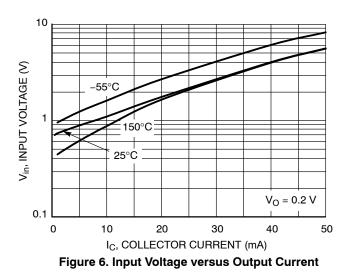
Figure 1. Derating Curve



TYPICAL CHARACTERISTICS – NPN TRANSISTOR MUN5333DW1, NSBC143ZPDXV6

Figure 4. Output Capacitance

Figure 5. Output Current versus Input Voltage



TYPICAL CHARACTERISTICS – PNP TRANSISTOR MUN5333DW1, NSBC143ZPDXV6

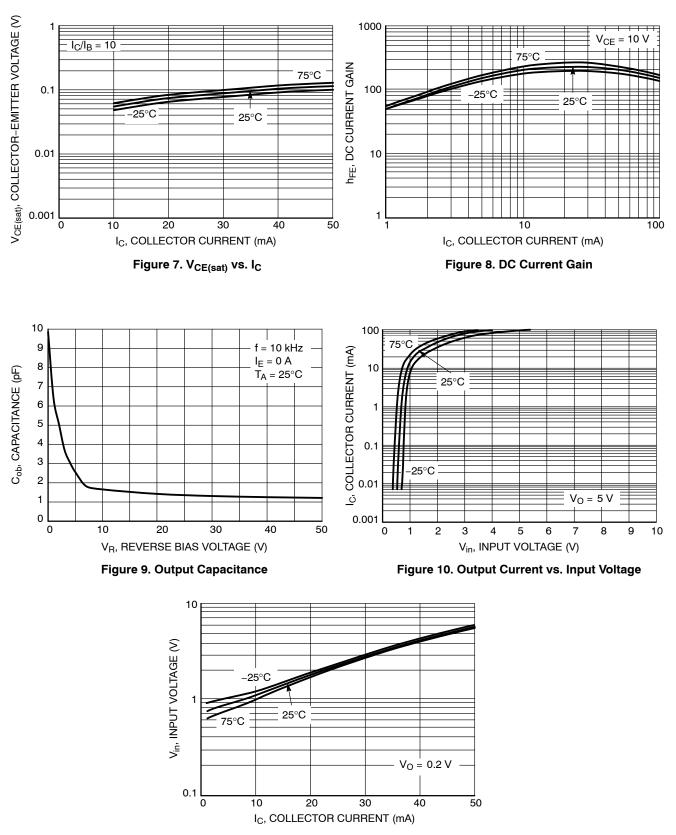
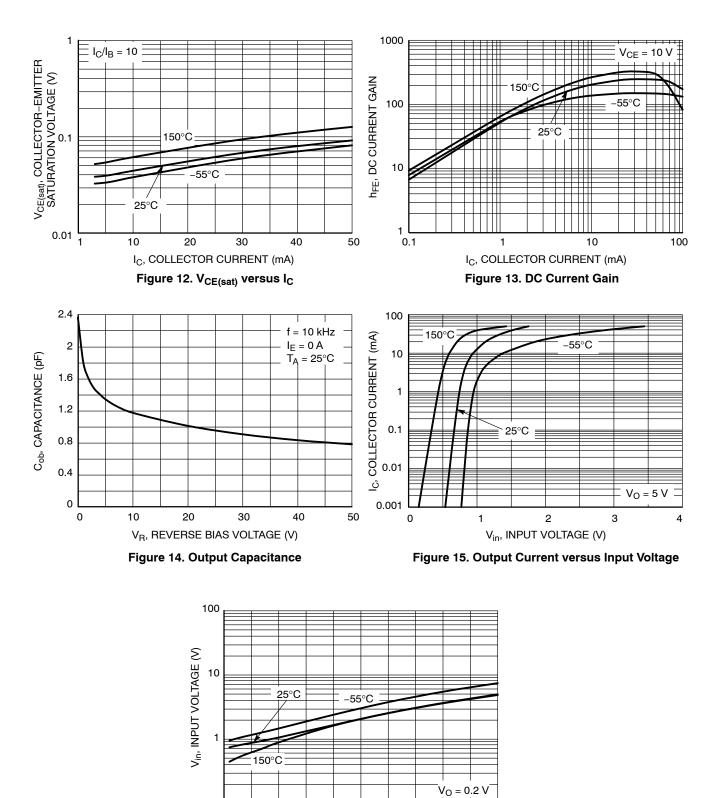


Figure 11. Input Voltage vs. Output Current

TYPICAL CHARACTERISTICS – NPN TRANSISTOR NSBC143ZPDP6



I_C, COLLECTOR CURRENT (mA) Figure 16. Input Voltage versus Output Current

30

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40

20

0.1 L 0

10

TYPICAL CHARACTERISTICS – PNP TRANSISTOR NSBC143ZPDP6

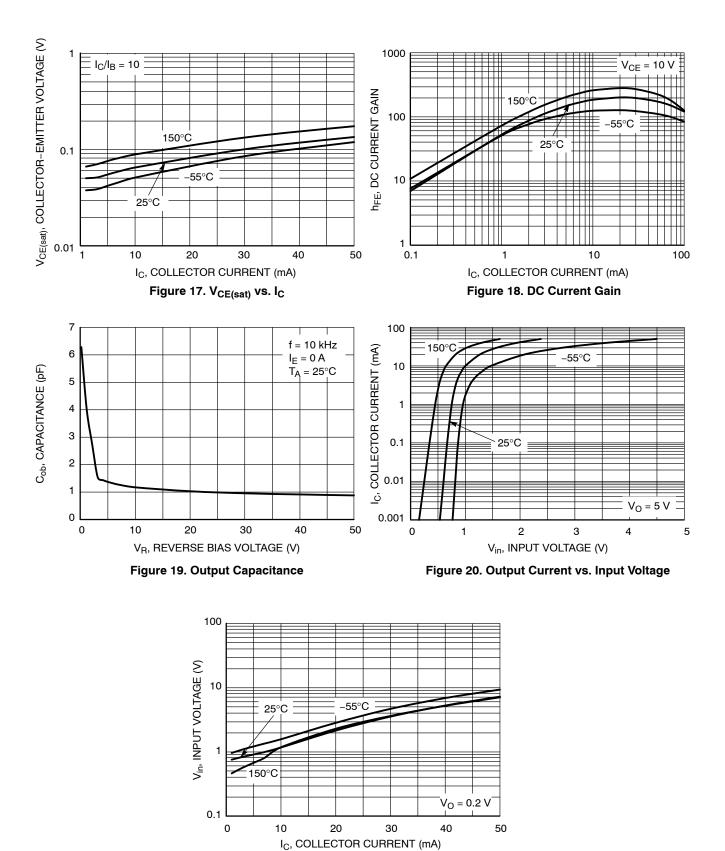
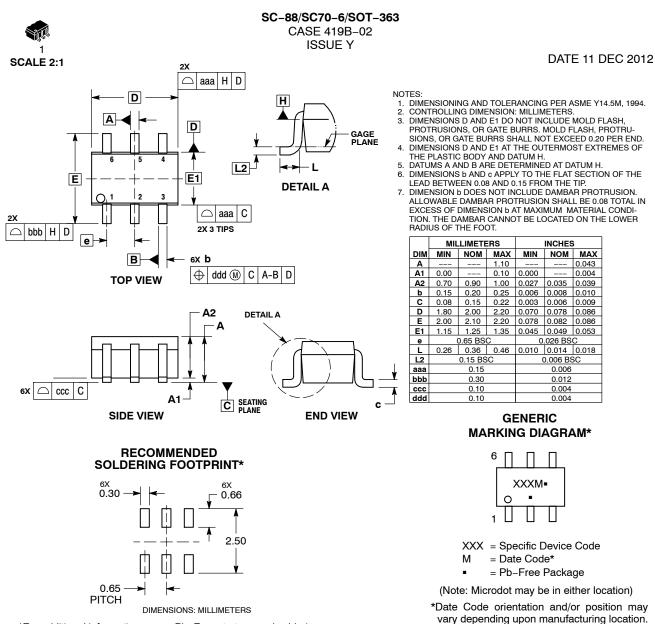
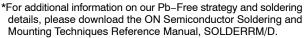


Figure 21. Input Voltage vs. Output Current







*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

STYLES ON PAGE 2

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SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

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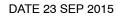
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SOT-563, 6 LEAD CASE 463A

ISSUE G



D -X-5 6 4 Ē HF 01 2 3 -b 6 PL С е \oplus 0.08 (0.003) 🔘 X | Y

2

1

STYLE 1:	STYLE 2:
PIN 1. EMITTER 1	PIN 1. EMITTER 1
2. BASE 1	2. EMITTER2
3. COLLECTOR 2	3. BASE 2
4. EMITTER 2	4. COLLECTOR
5. BASE 2	5. BASE 1
6. COLLECTOR 1	6. COLLECTOR
STYLE 4:	STYLE 5:
PIN 1. COLLECTOR	PIN 1. CATHODE
2. COLLECTOR	2. CATHODE
3. BASE	3. ANODE
4. EMITTER	4. ANODE
5. COLLECTOR	5. CATHODE

COLLECTOR 6. COLLECTOR STYLE 8: PIN 1. DRAIN PIN 1. CATHODE 2. ANODE 3. CATHODE

 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN
6. DRAIN

6. CATHODE

STYLE 7:

STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C

4. CATHODE 5. ANODE

6. CATHODE

- 5 N/C 6. ANODE 1

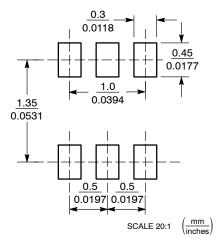
4. CATHODE 2 5. CATHODE 2 5 STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE

STYLE 9: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2

5. CATHODE 6. CATHODE

4. SOURCE 2 5. GATE 2 6. DRAIN 1

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. MILLIMETERS INCHES DIM MIN NOM MAX MIN NOM MAX

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETERS

NOTES

2.

3.

- 1		141114		INIAA	141114		
	Α	0.50	0.55	0.60	0.020	0.021	0.023
	q	0.17	0.22	0.27	0.007	0.009	0.011
	С	0.08	0.12	0.18	0.003	0.005	0.007
	D	1.50	1.60	1.70	0.059	0.062	0.066
I	Е	1.10	1.20	1.30	0.043	0.047	0.051
	e		0.5 BSC)	0	0.02 BSC)
	L	0.10	0.20	0.30	0.004	0.008	0.012
	HE	1.50	1.60	1.70	0.059	0.062	0.066

GENERIC **MARKING DIAGRAM***

XX M

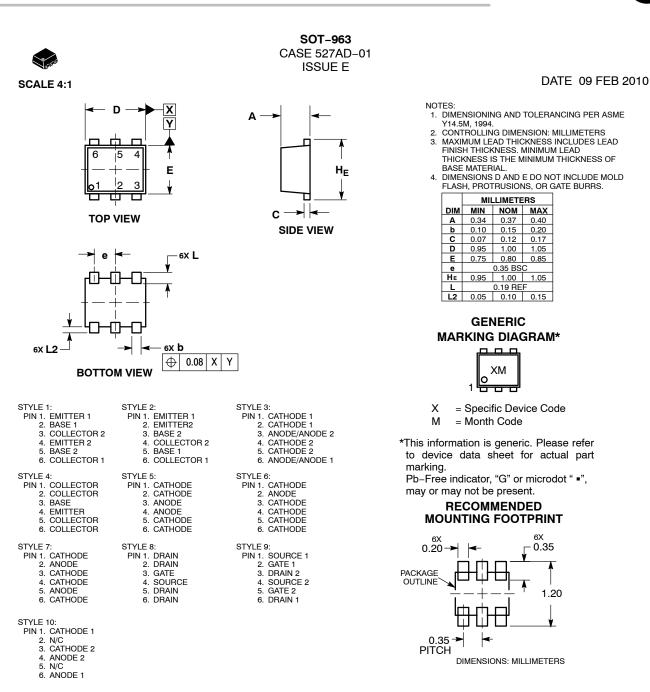
XX = Specific Device Code

- M = Month Code
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present.

STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2 6. ANODE/ANODE 1





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